IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Toshiyuki HIRANO et al.

Serial No. NEW : Attn: APPLICATION BRANCH

Filed September 8, 2003 : Attorney Docket No. 2003-1281

PROCESS FOR PRODUCING
HEAT-RESISTANT INTERMETALLIC
COMPOUND Ni₃AI FOIL HAVING
ROOM-TEMPERATURE DUCTILITY
AND HEAT-RESISTANT
INTERMETALLIC COMPOUND Ni₃AI
FOIL HAVING

ROOM-TEMPERATURE DUCTILITY

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEE FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975.

(Rule 1.53(b) Continuation of Serial No. 10/038,812, Filed January 8, 2002)

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Kindly amend the above-identified U.S. patent application as follows: